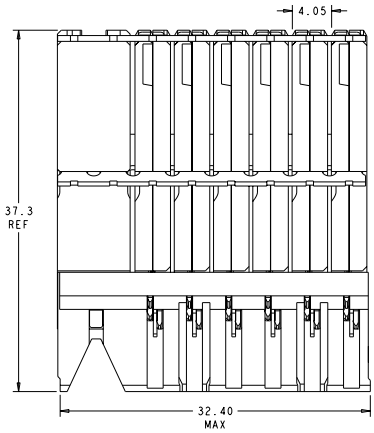
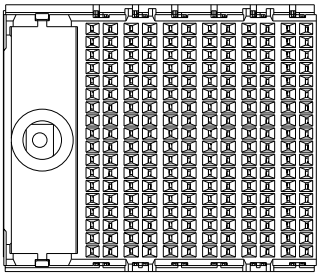
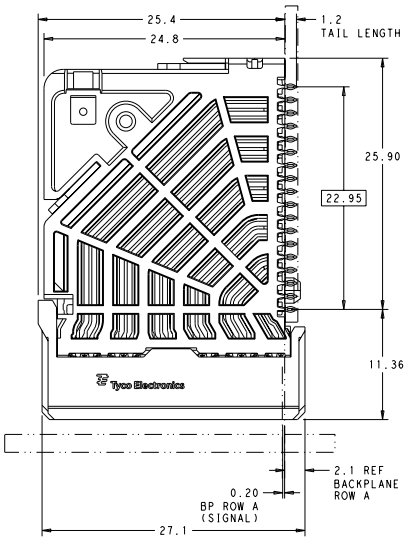
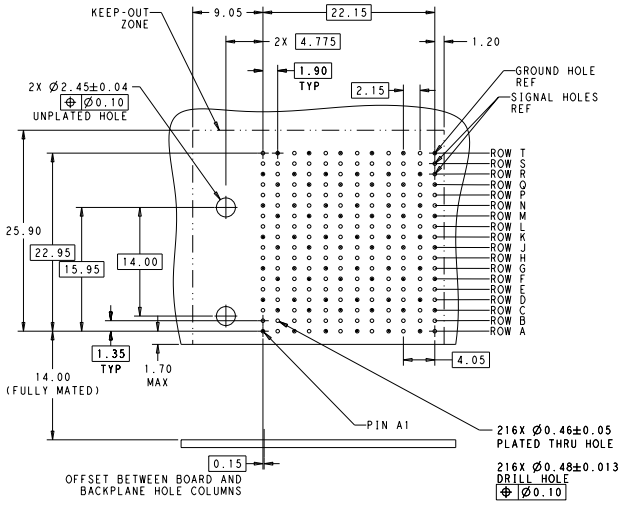








RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

LOC	DIST
AD	00

REVISIONS

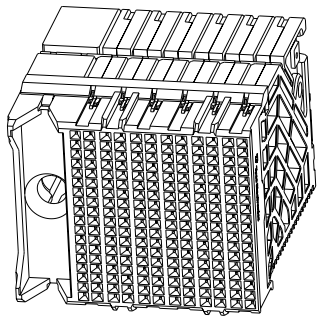
P	LTR	DESCRIPTION	DATE	DWN	APVD
	B	REVISED PER ECO-12-000423	16JAN2012	KH	DD

1. MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.

2. FINISH:
30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.

3. FINISH:
30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN-LEAD ON PCB TAILS, NICKEL OVERALL.

4. CONNECTORS SUPPLIED WITH MOUNTING SCREWS.



SCALE 4:1

REFER TO WWW.TE.COM
FOR PRODUCT AVAILABILITY

NONE	3	2132727-5
NONE	2	2132727-1
KEY POSITION	FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: MM

TOLERANCES UNLESS OTHERWISE SPECIFIED:
0 PLC ±
1 PLC ±0.25
2 PLC ±0.15
3 PLC ±
4 PLC ±
ANGLES ±

MATERIAL 1

FINISH SEE TABLE

DRN TSJAN2010
CHK D. DIXON TSJAN2010
APVD D. DIXON TSJAN2010
PRODUCT SPEC -
APPLICATION SPEC -
WEIGHT -

TE Connectivity

NAME IMPACT,ORTHOGONAL,6 PAIR, DAUGHTERCARD,12 COLUMN,LEFT GUIDED, SIGNAL MODULE,0.46 EYELET

SIZE A1 | CAGE CODE 00779 | DRAWING NO C-2132727 | RESTRICTED TO -

CUSTOMER DRAWING | SCALE 5:1 | SHEET 1 OF 1 | REV B

4805 12/111

Pro/ENGINEER DRAWING

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